

YK3400B

N-Channel Enhancement Mode Field Effect Transistor



General Description

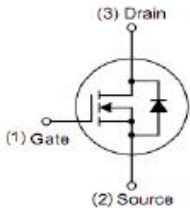
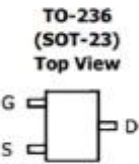
The YK3400B uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

Application

- PWM application
- Load switch
- Power management

Features

- $V_{DS} = 30V, I_D = 4A$
 $R_{DS(ON)} < 70m\Omega @ V_{GS} = 2.5V$
 $R_{DS(ON)} < 50m\Omega @ V_{GS} = 4.5V$
 $R_{DS(ON)} < 35m\Omega @ V_{GS} = 10V$
- High power and current handing capability
- Lead free product is acquired
- Surface mount package



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
A09T.	YK3400B	SOT-23	Ø180mm	8mm	3000 units

Absolute Maximum Ratings ($T_A = 25^\circ C$ unless otherwise noted)

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DSS}	30	V
Gate-Source Voltage	V_{GSS}	± 12	V
Drain Current-Continuous $V_{GS} = -4.5V, @T_A = 25^\circ C$	I_D	4	A
Drain Current –Pulsed ^{Note1}	I_{DM}	30	A
Maximum Power Dissipation $@T_A = 25^\circ C$	P_D	1.4	W
Operating Junction and Storage Temperature Range	T_J	$-55 \sim +150$	$^\circ C$

Thermal Characteristics

Thermal Resistance,Junction-to-Ambient ^{Note2}	$R_{\theta JA}$	89	$^\circ C/W$
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Electrical Characteristics ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D = -250μA	30		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -30V, V _{GS} = 0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±12V,V _{DS} = 0V	-	-	±100	nA
On Characteristics ^(Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _{DS} = -250μA	0.6	0.85	1.4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} = 10V, I _{DS} = 4.2A	-	20	35	mΩ
		V _{GS} = 4.5V, I _{DS} = 4A	-	28	50	
		V _{GS} = 2.5V, I _D = 2A	-	48	70	
Forward Transconductance	g _{FS}	V _{DS} =5V, I _D =5A	10	-	-	S
Dynamic Characteristics ^(Note4)						
Input Capacitance	C _{iss}	V _{DS} =15V , V _{GS} = 0V, F =1.0MHz	-	820	-	pF
Output Capacitance	C _{oss}		-	102	-	
Reverse Transfer Capacitance	C _{rss}		-	76	-	
Switching Characteristics ^(Note 4)						
Turn-on Delay Time	T _{d(on)}	V _{DD} =15V, RL=2.7Ω V _{GS} =10V,R _{GEN} =3Ω	-	4	-	ns
Turn-on Rise Time	T _r		-	5	-	
Turn-Off Delay Time	T _{d(OFF)}		-	27	-	
Turn-Off Fall Time	T _f		-	5	-	
Total Gate Charge	Q _g	V _{DS} =15V,I _D =5.8A, V _{GS} =4.5V	-	10	-	nC
Gate-Source Charge	Q _{gs}		-	1.8	-	
Gate-Drain Charge	Q _{gd}		-	3	-	
Drain-Source Diode Characteristics						
Diode Forward Voltage ^(Note 3)	V _{SD}	I _S =5.8A, V _{GS} =0V T _j = 25°C	-	-	1.2	V
Diode Forward Current ^(Note 2)	I _S		-	-	4	A

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production

Typical Electrical and Thermal Characteristics

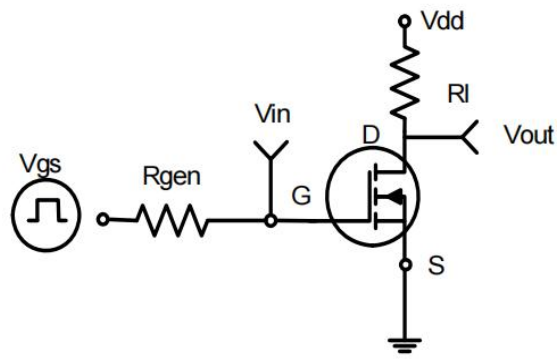


Figure 1:Switching Test Circuit

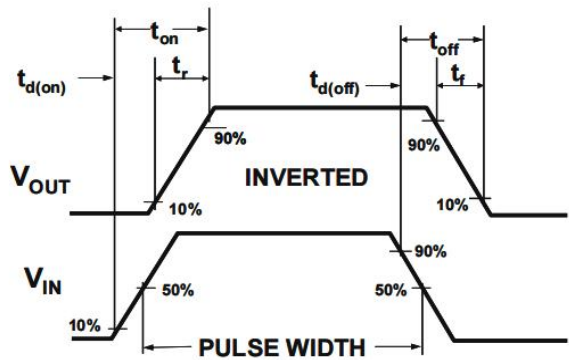


Figure 2:Switching Waveforms

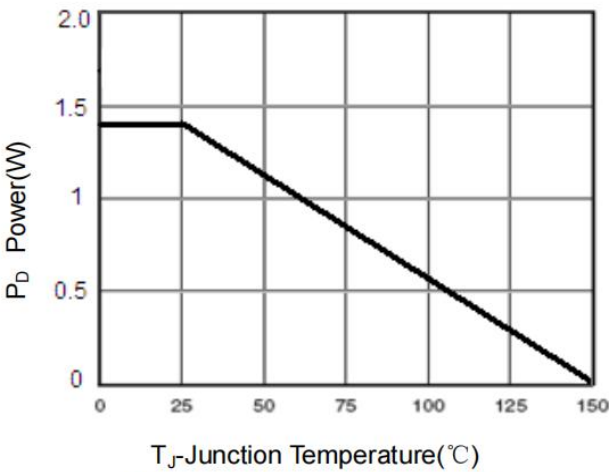


Figure 3 Power Dissipation

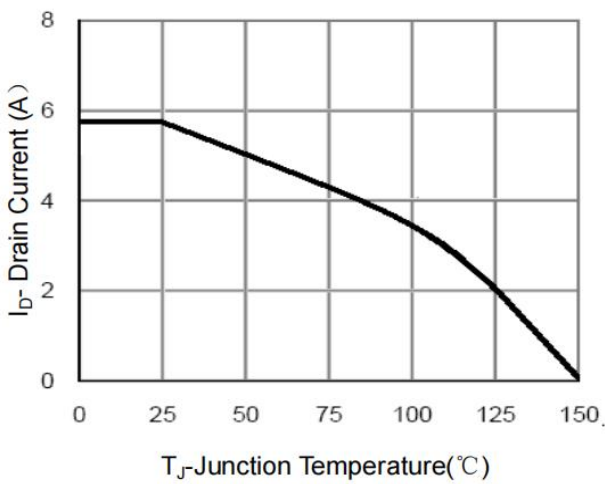


Figure 4 Drain Current

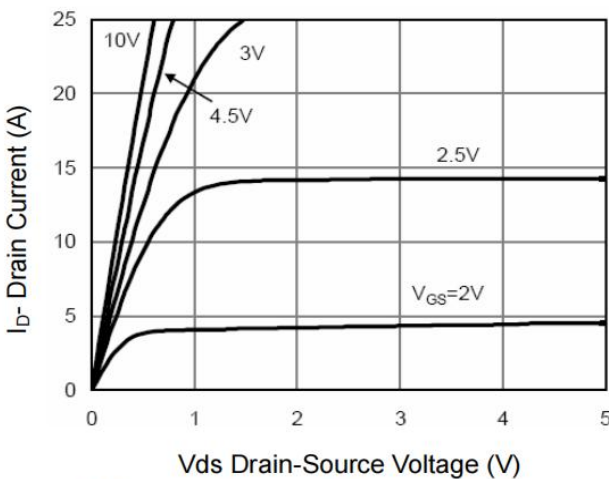


Figure 5 Output Characteristics

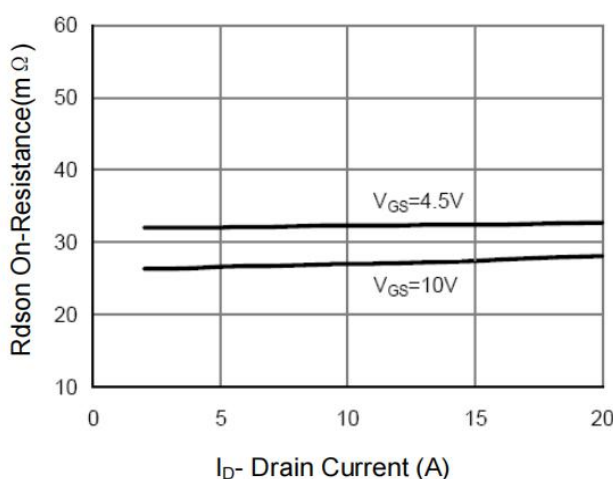
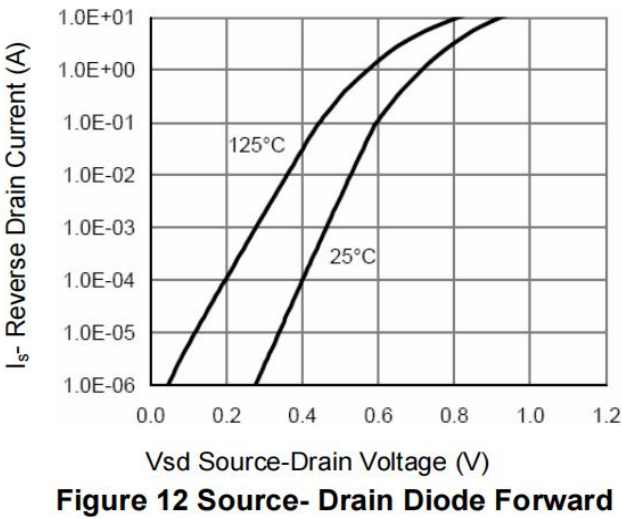
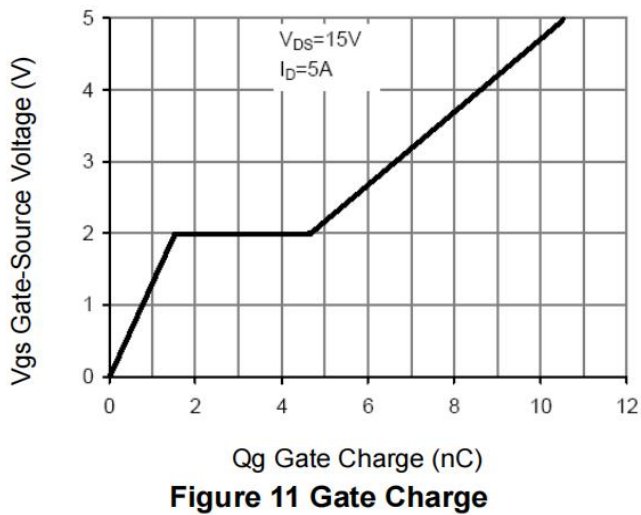
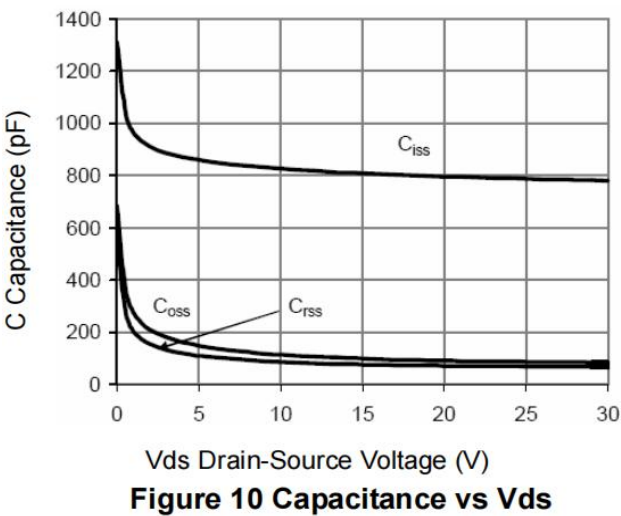
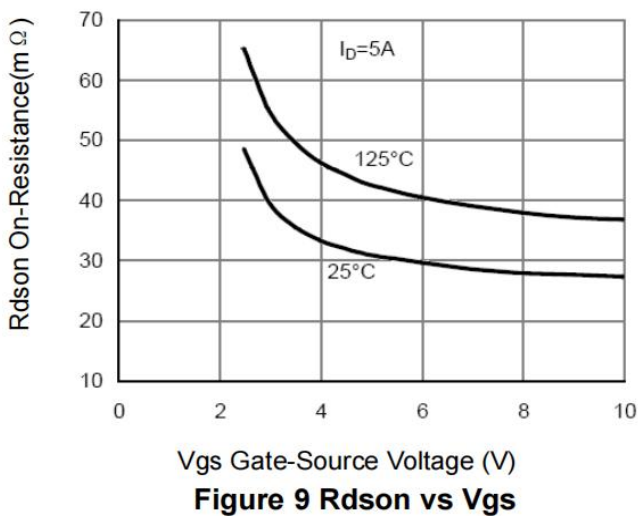
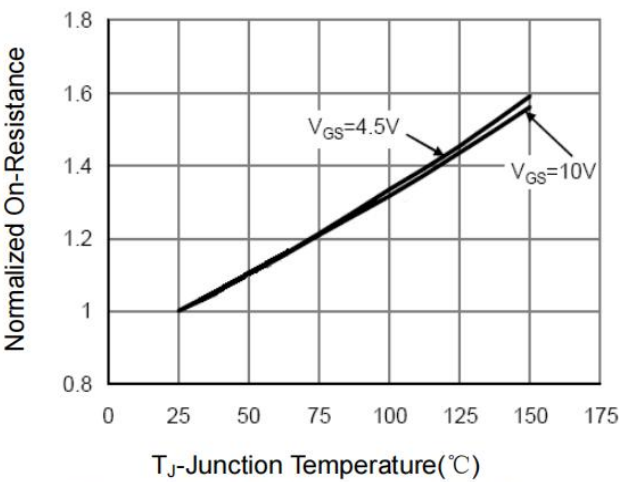
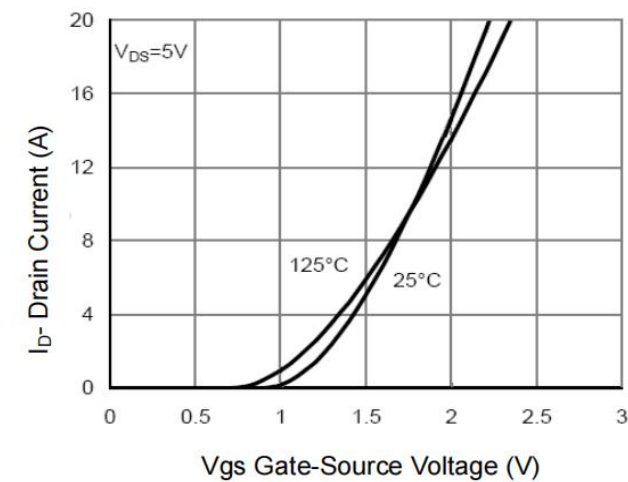


Figure 6 Drain-Source On-Resistance



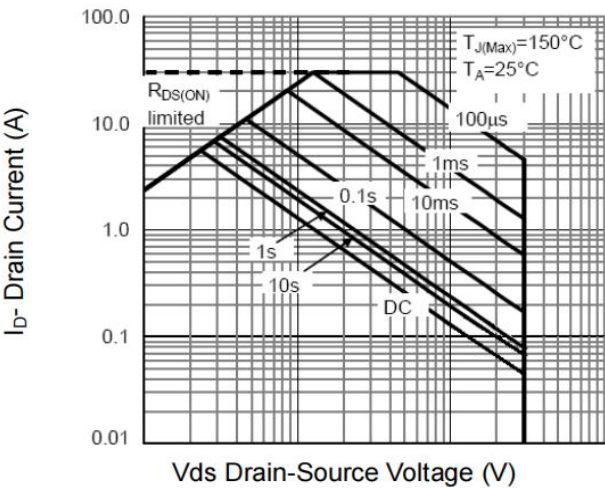


Figure 13 Safe Operation Area

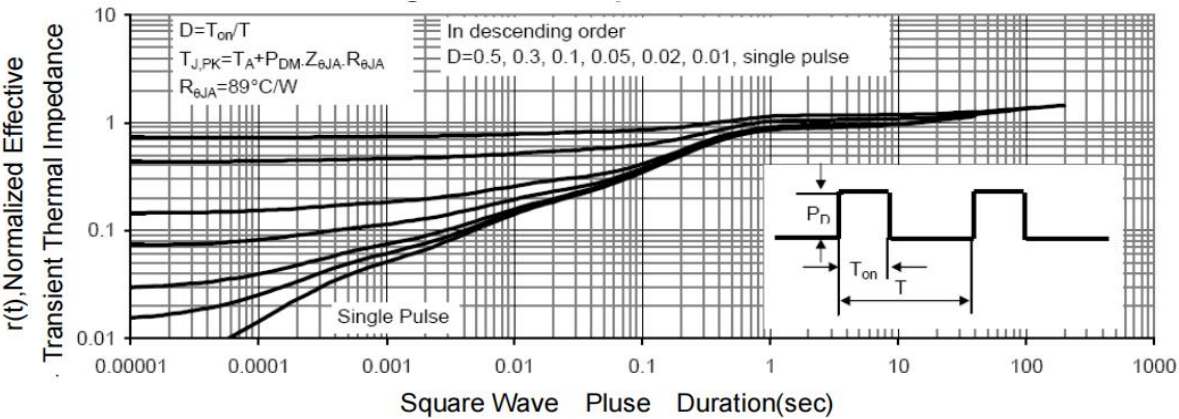


Figure 14 Normalized Maximum Transient Thermal Impedance

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SOT-23 Package Information

